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In the Claims:

Please amend Claims 46, 54, 58, 62 and 63 as follows:



46. (Amended) The method of claim 45, wherein the metallic oxide layer is formed of one selected from the group consisting of Al₂O₃, TiO₂, ZrO₂, Ta₂O₅ and CeO₂.



54. (Amended) The method of claim 53, wherein the metallic oxide layer is formed of one selected from the group consisting of Al₂O₃, TiO₂, ZrO₂, Ta₂O₅ and CeO₂.



58. (Amended) A method of forming a protective structure for a ferroelectric dielectric region on an integrated circuit substrate, the method comprising:

depositing a first metal oxide layer of a different material than the ferroelectric dielectric region directly on a surface of the ferroelectric dielectric region;

annealing the first metal oxide layer and the ferroelectric dielectric region; and depositing a second metal oxide layer on the first metal oxide layer.

62. (Amended) A method of forming a protective structure for a ferroelectric dielectric region on an integrated circuit substrate, the method comprising:

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depositing a first metal oxide layer directly on a surface of the ferroelectric dielectric region;

annealing the first metal oxide layer and the ferroelectric dielectric region; and depositing a second metal oxide layer on the first metal oxide layer,

wherein the first metal oxide layer comprises a metal oxide selected from the group consisting of Al₂O₃, TiO₂, ZrO₂, Ta₂O₅ and CeO₂; and

wherein the second metal oxide layer comprises a metal oxide selected from the group consisting of Al_2O_3 , TiO_2 , ZrO_2 , Ta_2O_5 and CeO_2 .

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63. (Amended) A method according to Claim 62, wherein the second metal oxide layer is thicker than the first metal oxide layer.

Please add Claims 73-77 as follows:

- 73. (New) A method according to Claim 58, wherein the first and second metal oxide layers are non-ferroelectric material layers.
 - 74. (New) A method according to Claim 58:

wherein the first metal oxide layer comprises a metal oxide selected from the group consisting of Al₂O₃, TiO₂, ZrO₂, Ta₂O₅ and CeO₂; and

wherein the second metal oxide layer comprises a metal oxide selected from the group consisting of Al₂O₃, TiO₂, ZrO₂, Ta₂O₅ and CeO₂.

- 75. (New) A method according to Claim 74, wherein the ferroelectric dielectric region comprises a ferroelectric material selected from the group consisting of SrTiO₃, BaTiO₃, (Ba, Sr)TiO₃, Pb(Zr, Ti)O₃, SrBi₂Ta₂O₉, (Pb, La)(Zr, Ti)O₃ and Bi₄Ti₃O₁₂.
- 76. (New) A method according to Claim 58, wherein the second metal oxide layer is thicker than the first metal oxide layer.
- 77. (New) A method according to Claim 62, wherein the ferroelectric dielectric region comprises a ferroelectric material selected from the group consisting of SrTiO₃, BaTiO₃, (Ba, Sr)TiO₃, Pb(Zr, Ti)O₃, SrBi₂Ta₂O₉, (Pb, La)(Zr, Ti)O₃ and Bi₄Ti₃O₁₂.

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